XN06435 (XN6435)

Silicon PNP epitaxial planer transistor

For high-frequency amplification

Features

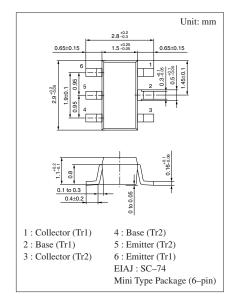
- Two elements incorporated into one package.
- Reduction of the mounting area and assembly cost by one half.

Basic Part Number of Element

• $2SA1022 \times 2$ elements

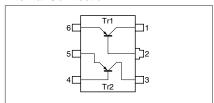
Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Rating of element	Collector to base voltage	V_{CBO}	-30	V	
	Collector to emitter voltage	V_{CEO}	-20	V	
	Emitter to base voltage	V_{EBO}	-5	V	
	Collector current	I_{C}	-30	mA	
Overall	Total power dissipation	P_{T}	300	mW	
	Junction temperature	T_{j}	150	°C	
	Storage temperature	T_{stg}	-55 to +150	°C	



Marking Symbol: 7W

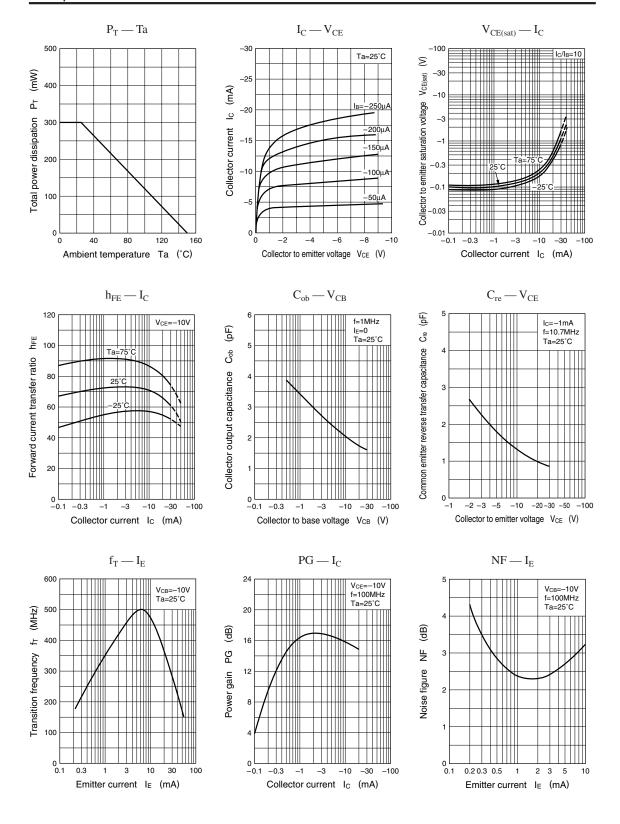
Internal Connection



Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -10V, I_E = 0$			-0.1	μА
Conector cutoff current	I_{CEO}	$V_{CE} = -20V, I_B = 0$			-100	μА
Emitter cutoff current	I_{EBO}	$V_{EB} = -5V$, $IC = 0$			-10	μΑ
Forward current transfer ratio	h_{FE}	$V_{CE} = -10V, I_{C} = -1mA$	50		220	
Forward current transfer h _{FE} ratio	h _{FE} (small/large)*1	$V_{CE} = -10V, I_{C} = -1mA$	0.5	0.99		
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{C} = -10 \text{mA}, I_{B} = -1 \text{mA}$		- 0.1		V
Base to emitter voltage	V_{BE}	$V_{CE} = -10V, I_{C} = -1mA$		- 0.7		V
Transition frequency	f_T	$V_{CB} = -10V$, $I_E = 1mA$, $f = 200MHz$	150			MHz
Noise figure	NF	$V_{CB} = -10V, I_E = 1mA, f = 5MHz$		2.8		dB
Reverse transfer impedance	Z_{rb}	$V_{CB} = -10V$, $I_E = 1mA$, $f = 2MHz$		22		Ω
Common emitter reverse transfer capacitance	C _{re}	$V_{CB} = -10V$, $I_E = 1mA$, $f = 10.7MHz$		1.2		pF

^{*1} Ratio between 2 elements



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